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## Understanding [Embedded - CPLDs \(Complex Programmable Logic Devices\)](#)

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

## Applications of Embedded - CPLDs

### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	7.5 ns
Voltage Supply - Internal	1.7V ~ 1.9V
Number of Logic Elements/Blocks	8
Number of Macrocells	128
Number of Gates	-
Number of I/O	96
Operating Temperature	0°C ~ 90°C (Tj)
Mounting Type	Surface Mount
Package / Case	132-LFBGA, CSPBGA
Supplier Device Package	132-CSBGA (8x8)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128zc-75m132c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4128zc-75m132c</a>

**Table 5. Product Term Expansion Capability**

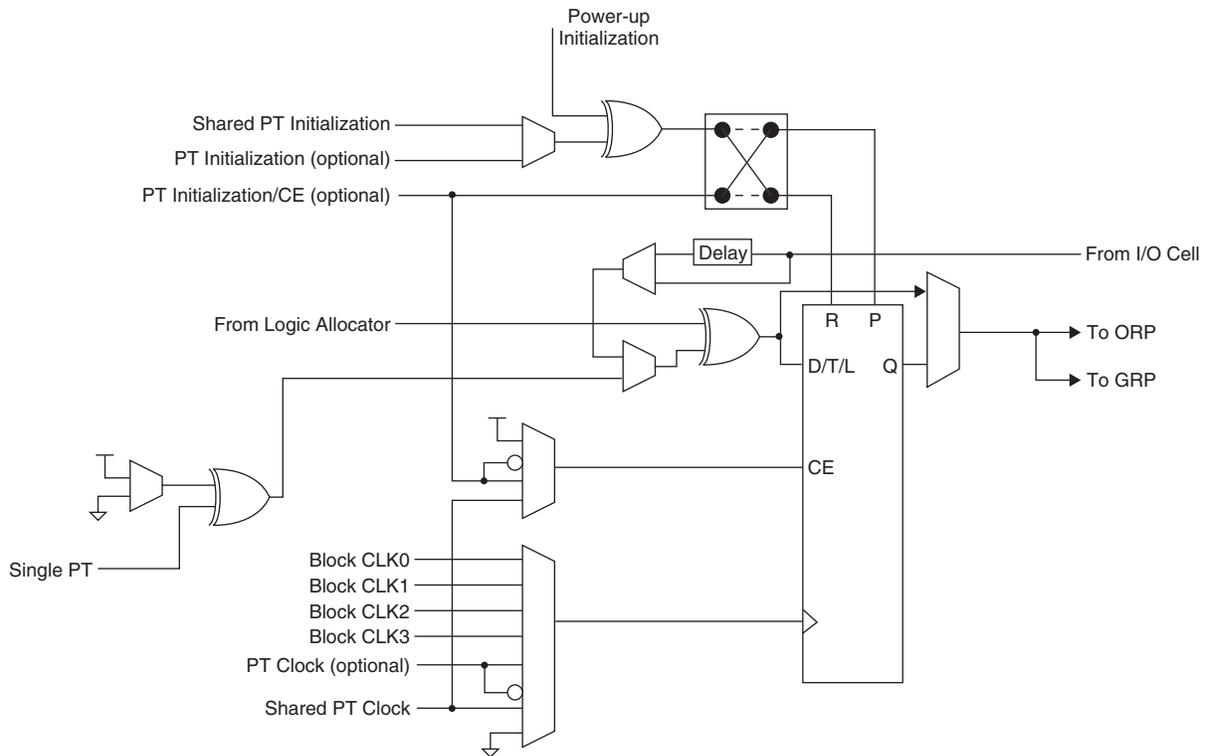
Expansion Chains	Macrocells Associated with Expansion Chain (with Wrap Around)	Max PT/Macrocell
Chain-0	M0 M4 M8 M12 M0	75
Chain-1	M1 M5 M9 M13 M1	80
Chain-2	M2 M6 M10 M14 M2	75
Chain-3	M3 M7 M11 M15 M3	70

Every time the super cluster allocator is used, there is an incremental delay of  $t_{EXP}$ . When the super cluster allocator is used, all destinations other than the one being steered to, are given the value of ground (i.e., if the super cluster is steered to M (n+4), then M (n) is ground).

**Macrocell**

The 16 macrocells in the GLB are driven by the 16 outputs from the logic allocator. Each macrocell contains a programmable XOR gate, a programmable register/latch, along with routing for the logic and control functions. Figure 5 shows a graphical representation of the macrocell. The macrocells feed the ORP and GRP. A direct input from the I/O cell allows designers to use the macrocell to construct high-speed input registers. A programmable delay in this path allows designers to choose between the fastest possible set-up time and zero hold time.

**Figure 5. Macrocell**

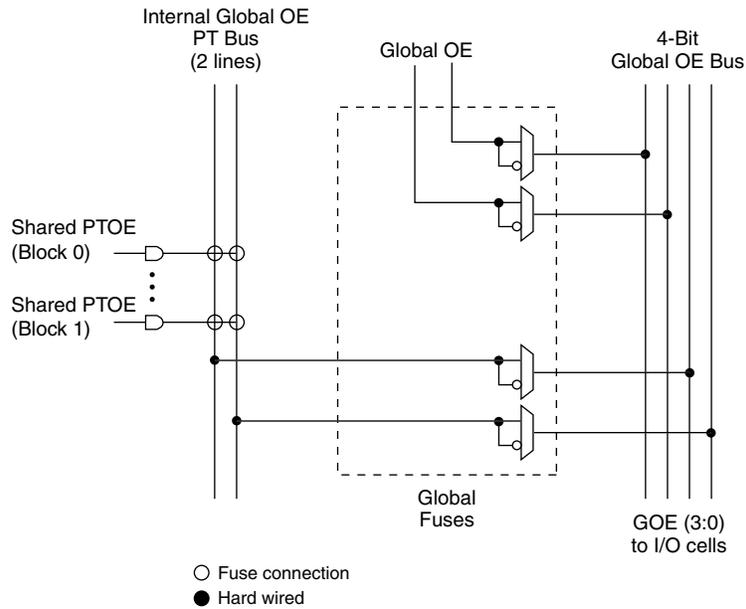


**Enhanced Clock Multiplexer**

The clock input to the flip-flop can select any of the four block clocks along with the shared PT clock, and true and complement forms of the optional individual term clock. An 8:1 multiplexer structure is used to select the clock. The eight sources for the clock multiplexer are as follows:

- Block CLK0
- Block CLK1

Figure 10. Global OE Generation for ispMACH 4032



## Zero Power/Low Power and Power Management

The ispMACH 4000 family is designed with high speed low power design techniques to offer both high speed and low power. With an advanced  $E^2$  low power cell and non sense-amplifier design approach (full CMOS logic approach), the ispMACH 4000 family offers SuperFAST pin-to-pin speeds, while simultaneously delivering low standby power without needing any “turbo bits” or other power management schemes associated with a traditional sense-amplifier approach.

The zero power ispMACH 4000Z is based on the 1.8V ispMACH 4000C family. With innovative circuit design changes, the ispMACH 4000Z family is able to achieve the industry’s “lowest static power”.

## IEEE 1149.1-Compliant Boundary Scan Testability

All ispMACH 4000 devices have boundary scan cells and are compliant to the IEEE 1149.1 standard. This allows functional testing of the circuit board on which the device is mounted through a serial scan path that can access all critical logic nodes. Internal registers are linked internally, allowing test data to be shifted in and loaded directly onto test nodes, or test node data to be captured and shifted out for verification. In addition, these devices can be linked into a board-level serial scan path for more board-level testing. The test access port operates with an LVCMOS interface that corresponds to the power supply voltage.

## I/O Quick Configuration

To facilitate the most efficient board test, the physical nature of the I/O cells must be set before running any continuity tests. As these tests are fast, by nature, the overhead and time that is required for configuration of the I/Os’ physical nature should be minimal so that board test time is minimized. The ispMACH 4000 family of devices allows this by offering the user the ability to quickly configure the physical nature of the I/O cells. This quick configuration takes milliseconds to complete, whereas it takes seconds for the entire device to be programmed. Lattice’s ispVM<sup>®</sup> System programming software can either perform the quick configuration through the PC parallel port, or can generate the ATE or test vectors necessary for a third-party test system.

## I/O Recommended Operating Conditions

Standard	$V_{CCO}$ (V) <sup>1</sup>	
	Min.	Max.
LVTTTL	3.0	3.6
LVC MOS 3.3	3.0	3.6
Extended LVC MOS 3.3 <sup>2</sup>	2.7	3.6
LVC MOS 2.5	2.3	2.7
LVC MOS 1.8	1.65	1.95
PCI 3.3	3.0	3.6

1. Typical values for  $V_{CCO}$  are the average of the min. and max. values.

2. ispMACH 4000Z only.

## DC Electrical Characteristics

### Over Recommended Operating Conditions

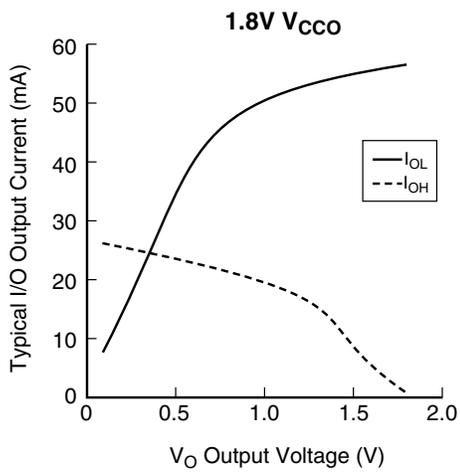
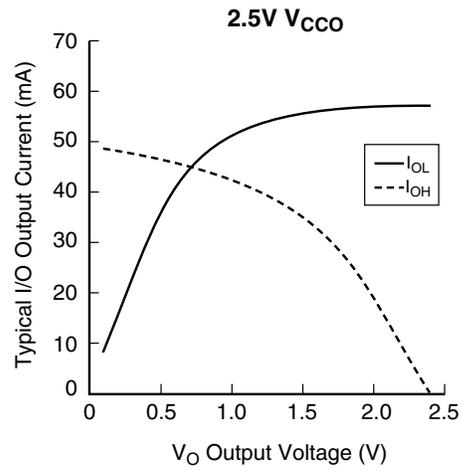
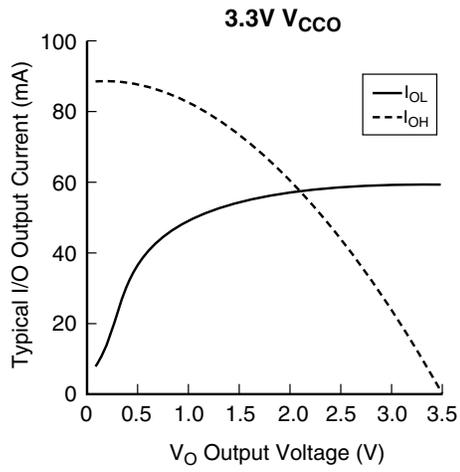
Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
$I_{IL}, I_{IH}^{1,4}$	Input Leakage Current (ispMACH 4000Z)	$0 \leq V_{IN} < V_{CCO}$	—	0.5	1	$\mu A$
$I_{IH}^1$	Input High Leakage Current (ispMACH 4000Z)	$V_{CCO} < V_{IN} \leq 5.5V$	—	—	10	$\mu A$
$I_{IL}, I_{IH}^1$	Input Leakage Current (ispMACH 4000V/B/C)	$0 \leq V_{IN} \leq 3.6V, T_j = 105^\circ C$	—	—	10	$\mu A$
		$0 \leq V_{IN} \leq 3.6V, T_j = 130^\circ C$	—	—	15	$\mu A$
$I_{IH}^{1,2}$	Input High Leakage Current (ispMACH 4000V/B/C)	$3.6V < V_{IN} \leq 5.5V, T_j = 105^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V^1$	—	—	20	$\mu A$
		$3.6V < V_{IN} \leq 5.5V, T_j = 130^\circ C$ $3.0V \leq V_{CCO} \leq 3.6V^1$	—	—	50	$\mu A$
$I_{PU}$	I/O Weak Pull-up Resistor Current (ispMACH 4000Z)	$0 \leq V_{IN} \leq 0.7V_{CCO}$	-30	—	-150	$\mu A$
	I/O Weak Pull-up Resistor Current (ispMACH 4000V/B/C)	$0 \leq V_{IN} \leq 0.7V_{CCO}$	-30	—	-200	$\mu A$
$I_{PD}$	I/O Weak Pull-down Resistor Current	$V_{IL} (MAX) \leq V_{IN} \leq V_{IH} (MIN)$	30	—	150	$\mu A$
$I_{BHLS}$	Bus Hold Low Sustaining Current	$V_{IN} = V_{IL} (MAX)$	30	—	—	$\mu A$
$I_{BHHS}$	Bus Hold High Sustaining Current	$V_{IN} = 0.7 V_{CCO}$	-30	—	—	$\mu A$
$I_{BHLO}$	Bus Hold Low Overdrive Current	$0V \leq V_{IN} \leq V_{BHT}$	—	—	150	$\mu A$
$I_{BHHO}$	Bus Hold High Overdrive Current	$V_{BHT} \leq V_{IN} \leq V_{CCO}$	—	—	-150	$\mu A$
$V_{BHT}$	Bus Hold Trip Points	—	$V_{CCO} * 0.35$	—	$V_{CCO} * 0.65$	V
$C_1$	I/O Capacitance <sup>3</sup>	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	8	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$	—		—	
$C_2$	Clock Capacitance <sup>3</sup>	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	6	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$	—		—	
$C_3$	Global Input Capacitance <sup>3</sup>	$V_{CCO} = 3.3V, 2.5V, 1.8V$	—	6	—	pf
		$V_{CC} = 1.8V, V_{IO} = 0$ to $V_{IH} (MAX)$	—		—	

1. Input or I/O leakage current is measured with the pin configured as an input or as an I/O with the output driver tristated. It is not measured with the output driver active. Bus maintenance circuits are disabled.

2. 5V tolerant inputs and I/O should only be placed in banks where  $3.0V \leq V_{CCO} \leq 3.6V$ .

3.  $T_A = 25^\circ C, f = 1.0MHz$

4.  $I_{IH}$  excursions of up to 1.5 $\mu A$  maximum per pin above the spec limit may be observed for certain voltage conditions on no more than 10% of the device's I/O pins.



**ispMACH 4000V/B/C External Switching Characteristics (Cont.)**

Over Recommended Operating Conditions

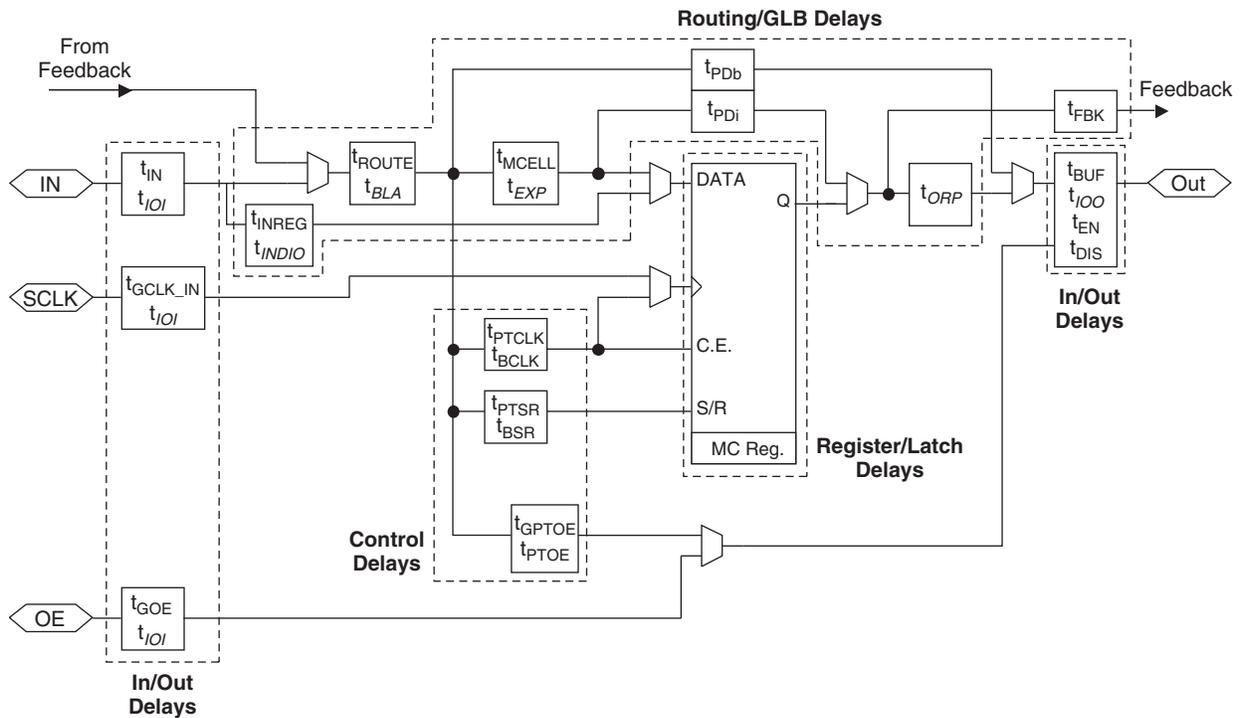
Parameter	Description <sup>1, 2, 3</sup>	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	5.0	—	7.5	—	10.0	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	5.5	—	8.0	—	10.5	ns
t <sub>S</sub>	GLB register setup time before clock	3.0	—	4.5	—	5.5	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	3.2	—	4.7	—	5.5	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.2	—	1.7	—	1.7	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.2	—	2.7	—	2.7	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.0	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.4	—	4.5	—	6.0	ns
t <sub>R</sub>	External reset pin to output delay	—	6.3	—	9.0	—	10.5	ns
t <sub>RW</sub>	External reset pulse duration	2.0	—	4.0	—	4.0	—	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	7.0	—	9.0	—	10.5	ns
t <sub>G<sub>P<sub>TOE/DIS</sub></sub></sub>	Input to output global product term output enable/disable	—	9.0	—	10.3	—	12.0	ns
t <sub>G<sub>OE/DIS</sub></sub>	Global OE input to output enable/disable	—	5.0	—	7.0	—	8.0	ns
t <sub>CW</sub>	Global clock width, high or low	2.2	—	2.8	—	4.0	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	2.2	—	2.8	—	4.0	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	2.2	—	2.8	—	4.0	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	227	—	168	—	125	MHz
f <sub>MAX</sub> (Ext.)	Clock frequency with external feedback, [1/ (t <sub>S</sub> + t <sub>CO</sub> )]	—	156	—	111	—	86	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards. Timing v.3.2
2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.
3. Pulse widths and clock widths less than minimum will cause unknown behavior.
4. Standard 16-bit counter using GRP feedback.

## Timing Model

The task of determining the timing through the ispMACH 4000 family, like any CPLD, is relatively simple. The timing model provided in Figure 11 shows the specific delay paths. Once the implementation of a given function is determined either conceptually or from the software report file, the delay path of the function can easily be determined from the timing model. The Lattice design tools report the timing delays based on the same timing model for a particular design. Note that the internal timing parameters are given for reference only, and are not tested. The external timing parameters are tested and guaranteed for every device. For more information on the timing model and usage, refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#).

Figure 11. ispMACH 4000 Timing Model



Note: Italicized items are optional delay adders.

## ispMACH 4000Z Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.75	—	0.80	—	0.75	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	2.25	—	2.25	—	2.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.60	—	1.60	—	1.95	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	0.75	—	0.90	—	0.90	ns
t <sub>EN</sub>	Output Enable Time	—	2.25	—	2.25	—	2.50	ns
t <sub>DIS</sub>	Output Disable Time	—	1.35	—	1.35	—	2.50	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	1.60	—	1.60	—	2.15	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.75	—	0.85	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	0.91	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.05	—	0.00	—	0.00	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.40	—	0.40	—	0.40	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.25	—	0.25	—	0.65	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	1.35	—	1.95	—	1.90	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.00	—	1.15	—	1.10	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	1.55	—	1.75	—	2.10	—	ns
t <sub>H</sub>	D-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>HT</sub>	T-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	0.94	—	0.90	—	1.50	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.06	—	1.20	—	1.10	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	0.88	—	1.00	—	1.00	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.65	—	0.70	—	0.65	ns
t <sub>CES</sub>	Clock Enable Setup Time	1.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	1.55	—	1.95	—	1.90	—	ns
t <sub>HL</sub>	Latch Hold Time	1.40	—	1.80	—	1.80	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.40	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.30	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.28	—	0.28	—	1.27	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	2.00	—	1.67	—	1.80	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.30	—	1.50	—	1.55	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.50	—	1.70	—	1.55	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.10	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.22	—	2.02	—	1.83	ns

## ispMACH 4000Z Internal Timing Parameters (Cont.)

Over Recommended Operating Conditions

Parameter	Description	-45		-5		-75		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.95	—	1.25	—	1.80	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	3.00	—	3.50	—	4.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.95	—	2.05	—	2.15	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	1.10	—	1.00	—	1.30	ns
t <sub>EN</sub>	Output Enable Time	—	2.50	—	2.50	—	2.70	ns
t <sub>DIS</sub>	Output Disable Time	—	2.50	—	2.50	—	2.70	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	2.25	—	2.05	—	2.50	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.65	—	1.00	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	1.00	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.35	—	0.05	—	0.05	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.20	—	0.70	—	1.90	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.45	—	0.65	—	1.00	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	1.00	—	1.10	—	1.35	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	2.10	—	1.90	—	2.45	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.20	—	1.30	—	1.55	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	2.30	—	2.10	—	2.75	—	ns
t <sub>H</sub>	D-Register Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>HT</sub>	T-Resister Hold Time	1.90	—	1.90	—	3.15	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	1.30	—	1.10	—	0.75	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.30	—	1.50	—	1.95	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	1.00	—	1.00	—	1.18	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.75	—	1.15	—	1.05	ns
t <sub>CES</sub>	Clock Enable Setup Time	2.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	1.00	—	1.00	—	1.65	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	2.10	—	1.90	—	2.15	—	ns
t <sub>HL</sub>	Latch Hold Time	2.00	—	2.00	—	1.17	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.25	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.97	—	0.97	—	0.28	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	1.80	—	1.80	—	1.67	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.55	—	1.55	—	1.25	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.83	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.83	—	1.83	—	2.72	ns
t <sub>GPTOE</sub>	Global PT OE Delay	—	4.30	—	4.20	—	3.50	ns

**ispMACH 4000Z Timing Adders (Cont.)<sup>1</sup>**

Adder Type	Base Parameter	Description	-45		-5		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.30	—	1.30	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.45	—	0.45	—	0.50	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>									
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

**ispMACH 4000V/B/C/Z Power Supply and NC Connections<sup>1</sup>**

Signal	44-pin TQFP <sup>2</sup>	48-pin TQFP <sup>2</sup>	56-ball csBGA <sup>3</sup>	100-pin TQFP <sup>2</sup>	128-pin TQFP <sup>2</sup>
VCC	11, 33	12, 36	K2, A9	25, 40, 75, 90	32, 51, 96, 115
VCCO0 VCCO (Bank 0)	6	6	F3	13, 33, 95	3, 17, 30, 41, 122
VCCO1 VCCO (Bank 1)	28	30	E8	45, 63, 83	58, 67, 81, 94, 105
GND	12, 34	13, 37	H3, C8	1, 26, 51, 76	1, 33, 65, 97
GND (Bank 0)	5	5	D3	7, 18, 32, 96	10, 24, 40, 113, 123
GND (Bank 1)	27	29	G8	46, 57, 68, 82	49, 59, 74, 88, 104
NC	—	—	<b>4032Z:</b> A8, B10, E1, E3, F8, F10, J1, K3	—	—

1. All grounds must be electrically connected at the board level. However, for the purposes of I/O current loading, grounds are associated with the bank shown.
2. Pin orientation follows the conventional order from pin 1 marking of the top side view and counter-clockwise.
3. Pin orientation A1 starts from the upper left corner of the top side view with alphabetical order ascending vertically and numerical order ascending horizontally.

**ispMACH 4032Z and 4064Z Logic Signal Connections: 56-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4032Z		ispMACH 4064Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
K5	0	A15	A <sup>15</sup>	B0	B <sup>0</sup>
H6	0	CLK1/I	-	CLK1/I	-
K6	1	CLK2/I	-	CLK2/I	-
H7	1	B0	B <sup>0</sup>	C0	C <sup>0</sup>
K7	1	B1	B <sup>1</sup>	C1	C <sup>1</sup>
K8	1	B2	B <sup>2</sup>	C2	C <sup>2</sup>
K9	1	B3	B <sup>3</sup>	C4	C <sup>3</sup>
K10	1	B4	B <sup>4</sup>	C6	C <sup>4</sup>
J10	-	TMS	-	TMS	-
H8	1	B5	B <sup>5</sup>	C8	C <sup>5</sup>
H10	1	B6	B <sup>6</sup>	C10	C <sup>6</sup>
G10	1	B7	B <sup>7</sup>	C11	C <sup>7</sup>
G8	1	GND (Bank 1)	-	GND (Bank 1)	-
F8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
F10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
E8	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E10	1	B8	B <sup>8</sup>	D15	D <sup>7</sup>
D8	1	B9	B <sup>9</sup>	D12	D <sup>6</sup>
D10	1	B10	B <sup>10</sup>	D10	D <sup>5</sup>
C10	1	B11	B <sup>11</sup>	D8	D <sup>4</sup>
B10	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A10	-	TDO	-	TDO	-
A9	-	VCC	-	VCC	-
C8	-	GND	-	GND	-
A8	1	NC <sup>1</sup>	-	I <sup>1</sup>	-
A7	1	B12	B <sup>12</sup>	D6	D <sup>3</sup>
C7	1	B13	B <sup>13</sup>	D4	D <sup>2</sup>
C6	1	B14	B <sup>14</sup>	D2	D <sup>1</sup>
A6	1	B15/GOE1	B <sup>15</sup>	D0/GOE1	D <sup>0</sup>
C5	1	CLK3/I	-	CLK3/I	-
A5	0	CLK0/I	-	CLK0/I	-
C4	0	A0/GOE0	A <sup>0</sup>	A0/GOE0	A <sup>0</sup>
A4	0	A1	A <sup>1</sup>	A1	A <sup>1</sup>
A3	0	A2	A <sup>2</sup>	A2	A <sup>2</sup>
A2	0	A3	A <sup>3</sup>	A4	A <sup>3</sup>
A1	0	A4	A <sup>4</sup>	A6	A <sup>4</sup>

1. For device migration considerations, these NC pins are input signal pins in ispMACH 4064Z devices.

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:  
100-Pin TQFP**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
1	-	GND	-	GND	-	GND	-
2	-	TDI	-	TDI	-	TDI	-
3	0	A8	A^8	B0	B^0	C12	C^3
4	0	A9	A^9	B2	B^1	C10	C^2
5	0	A10	A^10	B4	B^2	C6	C^1
6	0	A11	A^11	B6	B^3	C2	C^0
7	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
8	0	A12	A^12	B8	B^4	D12	D^3
9	0	A13	A^13	B10	B^5	D10	D^2
10	0	A14	A^14	B12	B^6	D6	D^1
11	0	A15	A^15	B13	B^7	D4	D^0
12*	0	I	-	I	-	I	-
13	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
14	0	B15	B^15	C14	C^7	E4	E^0
15	0	B14	B^14	C12	C^6	E6	E^1
16	0	B13	B^13	C10	C^5	E10	E^2
17	0	B12	B^12	C8	C^4	E12	E^3
18	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
19	0	B11	B^11	C6	C^3	F2	F^0
20	0	B10	B^10	C5	C^2	F6	F^1
21	0	B9	B^9	C4	C^1	F10	F^2
22	0	B8	B^8	C2	C^0	F12	F^3
23*	0	I	-	I	-	I	-
24	-	TCK	-	TCK	-	TCK	-
25	-	VCC	-	VCC	-	VCC	-
26	-	GND	-	GND	-	GND	-
27*	0	I	-	I	-	I	-
28	0	B7	B^7	D13	D^7	G12	G^3
29	0	B6	B^6	D12	D^6	G10	G^2
30	0	B5	B^5	D10	D^5	G6	G^1
31	0	B4	B^4	D8	D^4	G2	G^0
32	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
33	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
34	0	B3	B^3	D6	D^3	H12	H^3
35	0	B2	B^2	D4	D^2	H10	H^2
36	0	B1	B^1	D2	D^1	H6	H^1
37	0	B0	B^0	D0	D^0	H2	H^0
38	0	CLK1/I	-	CLK1/I	-	CLK1/I	-
39	1	CLK2/I	-	CLK2/I	-	CLK2/I	-
40	-	VCC	-	VCC	-	VCC	-
41	1	C0	C^0	E0	E^0	I2	I^0

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
19	0	D4	D <sup>2</sup>	E4	E <sup>2</sup>	G4	G <sup>2</sup>
20	0	D2	D <sup>1</sup>	E2	E <sup>1</sup>	G2	G <sup>1</sup>
21	0	D0	D <sup>0</sup>	E0	E <sup>0</sup>	G0	G <sup>0</sup>
22	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
23	0	E0	E <sup>0</sup>	H0	H <sup>0</sup>	J0	J <sup>0</sup>
24	0	E2	E <sup>1</sup>	H2	H <sup>1</sup>	J2	J <sup>1</sup>
25	0	E4	E <sup>2</sup>	H4	H <sup>2</sup>	J4	J <sup>2</sup>
26	0	E6	E <sup>3</sup>	H6	H <sup>3</sup>	J6	J <sup>3</sup>
27	0	E8	E <sup>4</sup>	H8	H <sup>4</sup>	J8	J <sup>4</sup>
28	0	E10	E <sup>5</sup>	H10	H <sup>5</sup>	J10	J <sup>5</sup>
29	0	E12	E <sup>6</sup>	H12	H <sup>6</sup>	J12	J <sup>6</sup>
30	0	E14	E <sup>7</sup>	H14	H <sup>7</sup>	J14	J <sup>7</sup>
31	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
32	0	F0	F <sup>0</sup>	J0	J <sup>0</sup>	N0	N <sup>0</sup>
33	0	F2	F <sup>1</sup>	J2	J <sup>1</sup>	N2	N <sup>1</sup>
34	0	F4	F <sup>2</sup>	J4	J <sup>2</sup>	N4	N <sup>2</sup>
35	0	F6	F <sup>3</sup>	J6	J <sup>3</sup>	N6	N <sup>3</sup>
36	0	F8	F <sup>4</sup>	J8	J <sup>4</sup>	N8	N <sup>4</sup>
37	0	F10	F <sup>5</sup>	J10	J <sup>5</sup>	N10	N <sup>5</sup>
38	0	F12	F <sup>6</sup>	J12	J <sup>6</sup>	N12	N <sup>6</sup>
39	0	F14	F <sup>7</sup>	J14	J <sup>7</sup>	N14	N <sup>7</sup>
40	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
41	-	TCK	-	TCK	-	TCK	-
42	-	VCC	-	VCC	-	VCC	-
43	-	NC	-	NC	-	NC	-
44	-	NC	-	NC	-	NC	-
45	-	NC	-	NC	-	NC	-
46	-	GND	-	GND (Bank 0)	-	GND	-
47	0	G14	G <sup>7</sup>	K14	K <sup>7</sup>	O14	O <sup>7</sup>
48	0	G12	G <sup>6</sup>	K12	K <sup>6</sup>	O12	O <sup>6</sup>
49	0	G10	G <sup>5</sup>	K10	K <sup>5</sup>	O10	O <sup>5</sup>
50	0	G8	G <sup>4</sup>	K8	K <sup>4</sup>	O8	O <sup>4</sup>
51	0	G6	G <sup>3</sup>	K6	K <sup>3</sup>	O6	O <sup>3</sup>
52	0	G4	G <sup>2</sup>	K4	K <sup>2</sup>	O4	O <sup>2</sup>
53	0	G2	G <sup>1</sup>	K2	K <sup>1</sup>	O2	O <sup>1</sup>
54	0	G0	G <sup>0</sup>	K0	K <sup>0</sup>	O0	O <sup>0</sup>
55	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
56	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
57	0	H14	H <sup>7</sup>	L14	L <sup>7</sup>	P14	P <sup>7</sup>
58	0	H12	H <sup>6</sup>	L12	L <sup>6</sup>	P12	P <sup>6</sup>
59	0	H10	H <sup>5</sup>	L10	L <sup>5</sup>	P10	P <sup>5</sup>

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
H15	1	M2	M^1	M1	M^1	DX2	DX^1	JX2	JX^1
H14	1	M4	M^2	M2	M^2	DX4	DX^2	JX4	JX^2
H13	1	M6	M^3	M4	M^3	DX6	DX^3	JX6	JX^3
G16	1	M8	M^4	M6	M^4	DX8	DX^4	JX8	JX^4
H12	1	M10	M^5	M8	M^5	DX10	DX^5	JX10	JX^5
G15	1	M12	M^6	M9	M^6	DX12	DX^6	JX12	JX^6
H11	1	M14	M^7	M10	M^7	DX14	DX^7	JX14	JX^7
F16	1	NC	-	M12	M^8	CX0	CX^0	IX0	IX^0
G13	1	NC	-	M14	M^9	CX2	CX^1	IX4	IX^1
G14	1	NC	-	NC	-	EX14	EX^7	KX0	KX^0
F15	1	NC	-	NC	-	EX12	EX^6	KX2	KX^1
E16	1	NC	-	NC	-	NC	-	KX4	KX^2
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
-	1	-	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E15	1	NC	-	NC	-	NC	-	KX6	KX^3
G12	1	NC	-	NC	-	EX10	EX^5	KX8	KX^4
E13	1	NC	-	NC	-	EX8	EX^4	KX10	KX^5
D16	1	NC	-	N0	N^0	CX4	CX^2	IX8	IX^2
E14	1	NC	-	N1	N^1	CX6	CX^3	IX12	IX^3
G11	1	N0	N^0	N2	N^2	FX0	FX^0	NX0	NX^0
D15	1	N2	N^1	N4	N^3	FX2	FX^1	NX2	NX^1
F11	1	N4	N^2	N6	N^4	FX4	FX^2	NX4	NX^2
C16	1	N6	N^3	N8	N^5	FX6	FX^3	NX6	NX^3
F12	1	N8	N^4	N9	N^6	FX8	FX^4	NX8	NX^4
D14	1	N10	N^5	N10	N^7	FX10	FX^5	NX10	NX^5
C15	1	N12	N^6	N12	N^8	FX12	FX^6	NX12	NX^6
B16	1	N14	N^7	N14	N^9	FX14	FX^7	NX14	NX^7
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
C14	-	TDO	-	TDO	-	TDO	-	TDO	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
A15	1	NC	-	NC	-	EX6	EX^3	KX12	KX^6
B14	1	NC	-	NC	-	EX4	EX^2	KX14	KX^7
E12	1	O14	O^7	O14	O^9	GX14	GX^7	OX14	OX^7
A14	1	O12	O^6	O12	O^8	GX12	GX^6	OX12	OX^6
C13	1	O10	O^5	O10	O^7	GX10	GX^5	OX10	OX^5
D13	1	O8	O^4	O9	O^6	GX8	GX^4	OX8	OX^4
E11	1	O6	O^3	O8	O^5	GX6	GX^3	OX6	OX^3
B13	1	O4	O^2	O6	O^4	GX4	GX^2	OX4	OX^2
F10	1	O2	O^1	O4	O^3	GX2	GX^1	OX2	OX^1

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
C12	1	O0	O^0	O2	O^2	GX0	GX^0	OX0	OX^0
E10	1	NC	-	O1	O^1	CX8	CX^4	MX0	MX^0
A13	1	NC	-	O0	O^0	CX10	CX^5	MX4	MX^1
D12	1	NC	-	NC	-	NC	-	LX0	LX^0
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B12	1	NC	-	NC	-	NC	-	LX4	LX^1
A12	1	NC	-	NC	-	EX2	EX^1	LX8	LX^2
B11	1	NC	-	NC	-	EX0	EX^0	LX12	LX^3
A11	1	NC	-	P14	P^9	CX12	CX^6	MX8	MX^2
D10	1	NC	-	P12	P^8	CX14	CX^7	MX12	MX^3
C10	1	P14	P^7	P10	P^7	HX14	HX^7	PX14	PX^7
B10	1	P12	P^6	P9	P6	HX12	HX^6	PX12	PX^6
A10	1	P10	P^5	P8	P^5	HX10	HX^5	PX10	PX^5
A9	1	P8	P^4	P6	P^4	HX8	HX^4	PX8	PX^4
F9	1	P6	P^3	P4	P^3	HX6	HX^3	PX6	PX^3
B9	1	P4	P^2	P2	P^2	HX4	HX^2	PX4	PX^2
E9	1	P2/GOE1	P^1	P1/GOE1	P^1	HX2/GOE1	HX^1	PX2/GOE1	PX^1
C9	1	P0	P^0	P0	P^0	HX0	HX^0	PX0	PX^0
-	-	GND	-	GND	-	GND	-	GND	-
D9	1	CLK3/I	-	CLK3/I	-	CLK3/I	-	CLK3/I	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
B8	0	CLK0/I	-	CLK0/I	-	CLK0/I	-	CLK0/I	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
D8	0	A0	A^0	A0	A^0	A0	A^0	A0	A^0
C8	0	A2/GOE0	A^1	A1/GOE0	A^1	A2/GOE0	A^1	A2/GOE0	A^1
A8	0	A4	A^2	A2	A^2	A4	A^2	A4	A^2
A7	0	A6	A^3	A4	A^3	A6	A^3	A6	A^3
B7	0	A8	A^4	A6	A^4	A8	A^4	A8	A^4
E8	0	A10	A^5	A8	A^5	A10	A^5	A10	A^5
D7	0	A12	A^6	A9	A^6	A12	A^6	A12	A^6
F8	0	A14	A^7	A10	A^7	A14	A^7	A14	A^7
C7	0	NC	-	A12	A^8	F14	F^7	D0	D^0
A6	0	NC	-	A14	A^9	F12	F^6	D4	D^1
B6	0	NC	-	NC	-	D14	D^7	E0	E^0
A5	0	NC	-	NC	-	D12	D^6	E4	E^1
B5	0	NC	-	NC	-	NC	-	E8	E^2
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
D5	0	NC	-	NC	-	NC	-	E12	E^3
A4	0	NC	-	B0	B^0	F10	F^5	D8	D^2

## ispMACH 4000C (1.8V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032C-75T48I	32	1.8	7.5	TQFP	48	32	I
	LC4032C-10T48I	32	1.8	10	TQFP	48	32	I
	LC4032C-5T44I	32	1.8	5	TQFP	44	30	I
	LC4032C-75T44I	32	1.8	7.5	TQFP	44	30	I
	LC4032C-10T44I	32	1.8	10	TQFP	44	30	I
LC4064C	LC4064C-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064C-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064C-10T100I	64	1.8	10	TQFP	100	64	I
	LC4064C-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064C-75T48I	64	1.8	7.5	TQFP	48	32	I
	LC4064C-10T48I	64	1.8	10	TQFP	48	32	I
	LC4064C-5T44I	64	1.8	5	TQFP	44	30	I
	LC4064C-75T44I	64	1.8	7.5	TQFP	44	30	I
LC4128C	LC4128C-5T128I	128	1.8	5	TQFP	128	92	I
	LC4128C-75T128I	128	1.8	7.5	TQFP	128	92	I
	LC4128C-10T128I	128	1.8	10	TQFP	128	92	I
	LC4128C-5T100I	128	1.8	5	TQFP	100	64	I
	LC4128C-75T100I	128	1.8	7.5	TQFP	100	64	I
	LC4128C-10T100I	128	1.8	10	TQFP	100	64	I
LC4256C	LC4256C-5FT256AI	256	1.8	5	ftBGA	256	128	I
	LC4256C-75FT256AI	256	1.8	7.5	ftBGA	256	128	I
	LC4256C-10FT256AI	256	1.8	10	ftBGA	256	128	I
	LC4256C-5FT256BI	256	1.8	5	ftBGA	256	160	I
	LC4256C-75FT256BI	256	1.8	7.5	ftBGA	256	160	I
	LC4256C-10FT256BI	256	1.8	10	ftBGA	256	160	I
	LC4256C-5F256AI <sup>1</sup>	256	1.8	5	fpBGA	256	128	I
	LC4256C-75F256AI <sup>1</sup>	256	1.8	7.5	fpBGA	256	128	I
	LC4256C-10F256AI <sup>1</sup>	256	1.8	10	fpBGA	256	128	I
	LC4256C-5F256BI <sup>1</sup>	256	1.8	5	fpBGA	256	160	I
	LC4256C-75F256BI <sup>1</sup>	256	1.8	7.5	fpBGA	256	160	I
	LC4256C-10F256BI <sup>1</sup>	256	1.8	10	fpBGA	256	160	I
	LC4256C-5T176I	256	1.8	5	TQFP	176	128	I
	LC4256C-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256C-10T176I	256	1.8	10	TQFP	176	128	I
	LC4256C-5T100I	256	1.8	5	TQFP	100	64	I
	LC4256C-75T100I	256	1.8	7.5	TQFP	100	64	I
	LC4256C-10T100I	256	1.8	10	TQFP	100	64	I

## ispMACH 4000B (2.5V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4384B	LC4384B-5FT256I	384	2.5	5	ftBGA	256	192	I
	LC4384B-75FT256I	384	2.5	7.5	ftBGA	256	192	I
	LC4384B-10FT256I	384	2.5	10	ftBGA	256	192	I
	LC4384B-5F256I <sup>1</sup>	384	2.5	5	fpBGA	256	192	I
	LC4384B-75F256I <sup>1</sup>	384	2.5	7.5	fpBGA	256	192	I
	LC4384B-10F256I <sup>1</sup>	384	2.5	10	fpBGA	256	192	I
	LC4384B-5T176I	384	2.5	5	TQFP	176	128	I
	LC4384B-75T176I	384	2.5	7.5	TQFP	176	128	I
	LC4384B-10T176I	384	2.5	10	TQFP	176	128	I
LC4512B	LC4512B-5FT256I	512	2.5	5	ftBGA	256	208	I
	LC4512B-75FT256I	512	2.5	7.5	ftBGA	256	208	I
	LC4512B-10FT256I	512	2.5	10	ftBGA	256	208	I
	LC4512B-5F256I <sup>1</sup>	512	2.5	5	fpBGA	256	208	I
	LC4512B-75F256I <sup>1</sup>	512	2.5	7.5	fpBGA	256	208	I
	LC4512B-10F256I <sup>1</sup>	512	2.5	10	fpBGA	256	208	I
	LC4512B-5T176I	512	2.5	5	TQFP	176	128	I
	LC4512B-75T176I	512	2.5	7.5	TQFP	176	128	I
	LC4512B-10T176I	512	2.5	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000V (3.3V) Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25T48C	32	3.3	2.5	TQFP	48	32	C
	LC4032V-5T48C	32	3.3	5	TQFP	48	32	C
	LC4032V-75T48C	32	3.3	7.5	TQFP	48	32	C
	LC4032V-25T44C	32	3.3	2.5	TQFP	44	30	C
	LC4032V-5T44C	32	3.3	5	TQFP	44	30	C
	LC4032V-75T44C	32	3.3	7.5	TQFP	44	30	C
LC4064V	LC4064V-25T100C	64	3.3	2.5	TQFP	100	64	C
	LC4064V-5T100C	64	3.3	5	TQFP	100	64	C
	LC4064V-75T100C	64	3.3	7.5	TQFP	100	64	C
	LC4064V-25T48C	64	3.3	2.5	TQFP	48	32	C
	LC4064V-5T48C	64	3.3	5	TQFP	48	32	C
	LC4064V-75T48C	64	3.3	7.5	TQFP	48	32	C
	LC4064V-25T44C	64	3.3	2.5	TQFP	44	30	C
	LC4064V-5T44C	64	3.3	5	TQFP	44	30	C
LC4064V-75T44C	64	3.3	7.5	TQFP	44	30	C	

## ispMACH 4000V (3.3V) Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75T48E	32	3.3	7.5	TQFP	48	32	E
	LC4032V-75T44E	32	3.3	7.5	TQFP	44	30	E
LC4064V	LC4064V-75T100E	64	3.3	7.5	TQFP	100	64	E
	LC4064V-75T48E	64	3.3	7.5	TQFP	48	32	E
	LC4064V-75T44E	64	3.3	7.5	TQFP	44	30	E
LC4128V	LC4128V-75T144E	128	3.3	7.5	TQFP	144	96	E
	LC4128V-75T128E	128	3.3	7.5	TQFP	128	92	E
	LC4128V-75T100E	128	3.3	7.5	TQFP	100	64	E
LC4256V	LC4256V-75T176E	256	3.3	7.5	TQFP	176	128	E
	LC4256V-75T144E	256	3.3	7.5	TQFP	144	96	E
	LC4256V-75T100E	256	3.3	7.5	TQFP	100	64	E

**ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Industrial Devices (Cont.)**

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4064ZC	LC4064ZC-5MN132I	64	1.8	5	Lead-free csBGA	132	64	I
	LC4064ZC-75MN132I	64	1.8	7.5	Lead-free csBGA	132	64	I
	LC4064ZC-5TN100I	64	1.8	5	Lead-free TQFP	100	64	I
	LC4064ZC-75TN100I	64	1.8	7.5	Lead-free TQFP	100	64	I
	LC4064ZC-5MN56I	64	1.8	5	Lead-free csBGA	56	32	I
	LC4064ZC-75MN56I	64	1.8	7.5	Lead-free csBGA	56	32	I
	LC4064ZC-5TN48I	64	1.8	5	Lead-free TQFP	48	32	I
	LC4064ZC-75TN48I	64	1.8	7.5	Lead-free TQFP	48	32	I
LC4128ZC	LC4128ZC-75MN132I	128	1.8	7.5	Lead-free csBGA	132	96	I
	LC4128ZC-75TN100I	128	1.8	7.5	Lead-free TQFP	100	64	I
LC4256ZC	LC4256ZC-75TN176I	256	1.8	7.5	Lead-free TQFP	176	128	I
	LC4256ZC-75MN132I	256	1.8	7.5	Lead-free csBGA	132	96	I
	LC4256ZC-75TN100I	256	1.8	7.5	Lead-free TQFP	100	64	I

**ispMACH 4000Z (Zero Power, 1.8V) Lead-Free Extended Temperature Devices**

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032ZC	LC4032ZC-75TN48E	32	1.8	7.5	Lead-free TQFP	48	32	E
LC4064ZC	LC4064ZC-75TN100E	64	1.8	7.5	Lead-free TQFP	100	64	E
	LC4064ZC-75TN48E	64	1.8	7.5	Lead-free TQFP	48	32	E
LC4128ZC	LC4128ZC-75TN100E	128	1.8	7.5	Lead-free TQFP	100	64	E
LC4256ZC	LC4256ZC-75TN176E	256	1.8	7.5	Lead-free TQFP	176	128	E
	LC4256ZC-75TN100E	256	1.8	7.5	Lead-free TQFP	100	64	E

**ispMACH 4000C (1.8V) Lead-Free Commercial Devices**

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-25TN48C	32	1.8	2.5	Lead-free TQFP	48	32	C
	LC4032C-5TN48C	32	1.8	5	Lead-free TQFP	48	32	C
	LC4032C-75TN48C	32	1.8	7.5	Lead-free TQFP	48	32	C
	LC4032C-25TN44C	32	1.8	2.5	Lead-free TQFP	44	30	C
	LC4032C-5TN44C	32	1.8	5	Lead-free TQFP	44	30	C
	LC4032C-75TN44C	32	1.8	7.5	Lead-free TQFP	44	30	C

## ispMACH 4000V (3.3V) Lead-Free Commercial Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-25TN48C	32	3.3	2.5	Lead-free TQFP	48	32	C
	LC4032V-5TN48C	32	3.3	5	Lead-free TQFP	48	32	C
	LC4032V-75TN48C	32	3.3	7.5	Lead-free TQFP	48	32	C
	LC4032V-25TN44C	32	3.3	2.5	Lead-free TQFP	44	30	C
	LC4032V-5TN44C	32	3.3	5	Lead-free TQFP	44	30	C
	LC4032V-75TN44C	32	3.3	7.5	Lead-free TQFP	44	30	C
LC4064V	LC4064V-25TN100C	64	3.3	2.5	Lead-free TQFP	100	64	C
	LC4064V-5TN100C	64	3.3	5	Lead-free TQFP	100	64	C
	LC4064V-75TN100C	64	3.3	7.5	Lead-free TQFP	100	64	C
	LC4064V-25TN48C	64	3.3	2.5	Lead-free TQFP	48	32	C
	LC4064V-5TN48C	64	3.3	5	Lead-free TQFP	48	32	C
	LC4064V-75TN48C	64	3.3	7.5	Lead-free TQFP	48	32	C
	LC4064V-25TN44C	64	3.3	2.5	Lead-free TQFP	44	30	C
	LC4064V-5TN44C	64	3.3	5	Lead-free TQFP	44	30	C
LC4064V-75TN44C	64	3.3	7.5	Lead-free TQFP	44	30	C	
LC4128V	LC4128V-27TN144C	128	3.3	2.7	Lead-free TQFP	144	96	C
	LC4128V-5TN144C	128	3.3	5	Lead-free TQFP	144	96	C
	LC4128V-75TN144C	128	3.3	7.5	Lead-free TQFP	144	96	C
	LC4128V-27TN128C	128	3.3	2.7	Lead-free TQFP	128	92	C
	LC4128V-5TN128C	128	3.3	5	Lead-free TQFP	128	92	C
	LC4128V-75TN128C	128	3.3	7.5	Lead-free TQFP	128	92	C
	LC4128V-27TN100C	128	3.3	2.7	Lead-free TQFP	100	64	C
	LC4128V-5TN100C	128	3.3	5	Lead-free TQFP	100	64	C
LC4128V-75TN100C	128	3.3	7.5	Lead-free TQFP	100	64	C	